CRS20I30B

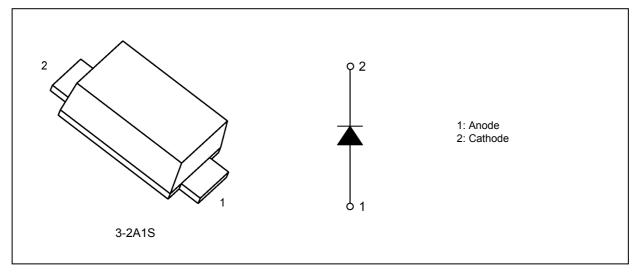
1. Applications

- Secondary Rectification in Switching Regulators
- Reverse-Current Protection in Mobile Devices

2. Features

- (1) Peak forward voltage: V_{FM} = 0.45 V (max) @I_{FM} = 2 A
- (2) Average forward current: $I_{F(AV)} = 2 A$
- (3) Repetitive peak reverse voltage: $V_{RRM} = 30 V$
- (4) Small, thin package suitable for high-density board assembly Toshiba Nickname: S-FLATTM

3. Packaging and Internal Circuit



4. Absolute Maximum Ratings (Note) (Unless otherwise specified, $T_a = 25$ °C)

Characteristics	Symbol	Note	Rating	Unit
Repetitive peak reverse voltage	V _{RRM}		30	V
Average forward current	I _{F(AV)}	(Note 1)	2	А
Non-repetitive peak forward surge current	I _{FSM}	(Note 2)	30	
Junction temperature	Тj		150	°C
Storage temperature	T _{stg}		-55 to 150	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: T_{ℓ} = 105 °C, square wave (α = 180°), V_R = 15 V

Note 2: f = 50 Hz, half-sine wave

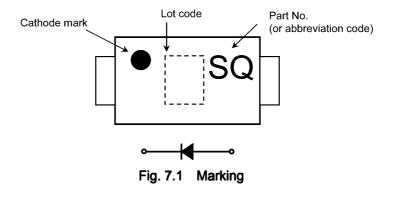
5. Thermal Characteristics

Characteristics	Symbol	Note	Test Condition	Max	Unit
Thermal resistance (junction-to-ambient)	R _{th(j-a)}	Device mounted on a ceramic board (board size: 50 mm × 50 mm) (soldering land size: 2 mm × 2 mm) (board thickness: 0.64 mm)		70	°C/W
			Device mounted on a glass-epoxy board (board size: 50 mm \times 50 mm) (soldering land size: 6 mm \times 6 mm) (board thickness: 1.6 mm)	140	
Thermal resistance (junction-to-lead)	R _{th(j-l)}		Junction to cathode lead	20	°C/W

6. Electrical Characteristics (Unless otherwise specified, $T_a = 25$ °C)

Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
Peak forward voltage	V _{FM(1)}		I _{FM} = 0.1 A (pulse measurement)	—	0.25	—	V
	V _{FM(2)}		I _{FM} = 1.0 A (pulse measurement)	_	0.33	_	
	V _{FM(3)}		I _{FM} = 2.0 A (pulse measurement)	_	0.35	0.45	
Repetitive peak reverse current	I _{RRM(1)}		V _{RRM} = 5 V (pulse measurement)	_	14	—	μA
	I _{RRM(2)}		V _{RRM} = 30 V (pulse measurement)	_	28	100	
Junction capacitance	Cj		V _R = 10 V, f = 1 MHz		82	_	pF

7. Marking



Marking Code	Part Number		
SQ	CRS20I30B		

8. Usage Considerations

- (1) Schottky barrier diodes (SBDs) have reverse current greater than other types of diodes. This makes SBDs more vulnerable to damage due to thermal runaway under high-temperature and high-voltage conditions. Thus, both forward and reverse power losses of SBDs should be considered for thermal and safety design.
- (2) The absolute maximum ratings are rated values that must not be exceeded during operation, even for an instant. The following are the recommended general derating methods for designing a circuit board using this device.

V_{RRM}:Use this rating with reference to (1) above. V_{RRM} has a temperature coefficient of 0.1 %/°C at low temperatures. Take this coefficient into account when designing a circuit board that will be operated in a low-temperature environment.

 $I_{F(AV)}: We recommend that the worst-case current be no greater than 80 \% of the absolute maximum rating of I_{F(AV)} and that the worst-case junction temperature, T_j, be kept below 120 °C. When using this device,$

allow margins, referring to the $T_{a(max)}\mathchar`-I_{F(AV)}$ curve.

- I_{FSM} : This rating specifies peak non-repetitive forward surge current. This only applies to an abnormal operation, which seldom occurs during the lifespan of a device.
- $\begin{array}{ll} T_j & \mbox{ Derate device parameters in proportion to this rating in order to ensure high reliability.} \\ & \mbox{ We recommend that the junction temperature } (T_j) \mbox{ of a device be kept below 120 °C.} \end{array}$
- (3) Thermal resistance (junction-to-ambient) varies with the mounting conditions of a device on a circuit board. An appropriate thermal resistance value should be used, considering the heat sink, circuit board design and land pattern dimensions (provided for reference only).
- (4) For other design considerations, see the Rectifiers databook or the Toshiba Semiconductor website.

9. Land Pattern Dimensions (for reference only)

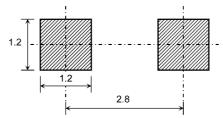


Fig. 9.1 Land Pattern Dimensions for Reference Only (Unit: mm)

3

10. Characteristics Curves (Note)

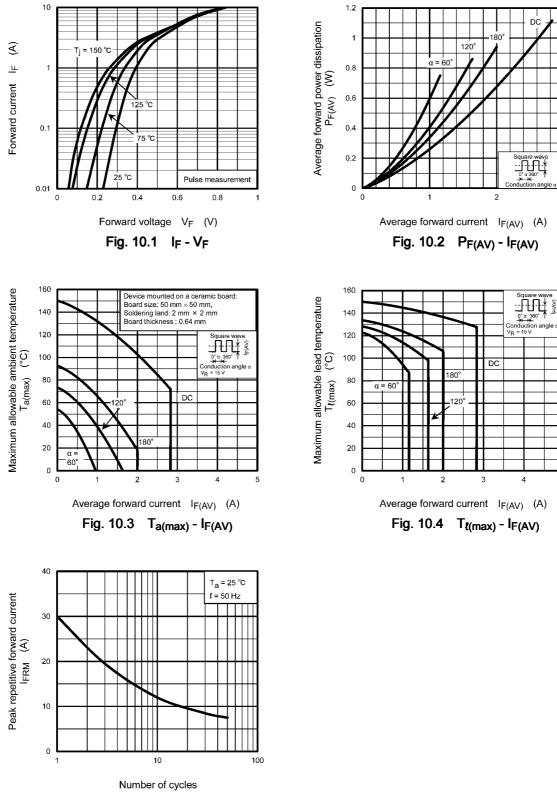
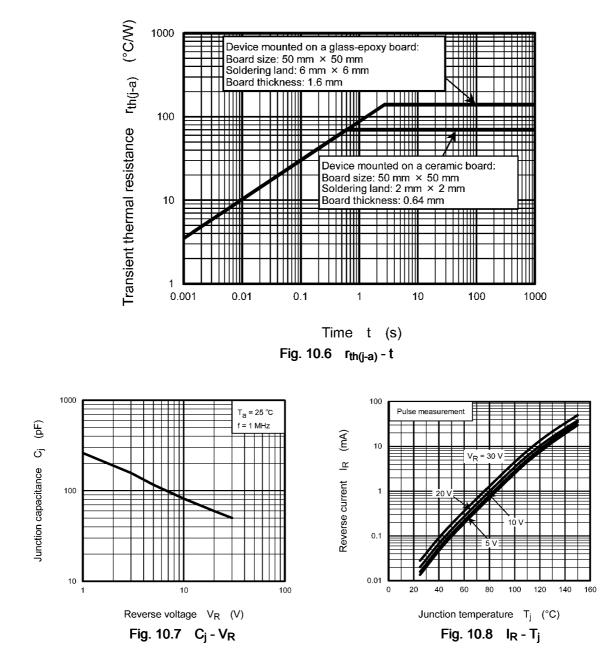


Fig. 10.5 Peak Repetitive Forward Current



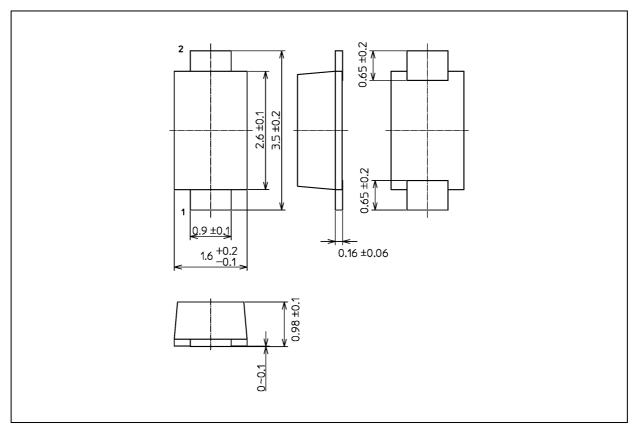
Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



CRS20I30B

Package Dimensions

Unit: mm



Weight: 0.013 g (typ.)

Package Name(s)			
TOSHIBA: 3-2A1S			
Nickname: S-FLAT			

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